

TD827 Series

Description

The TD827 series provide two channel operation, and each combines an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic DIP8 package with different lead forming options.

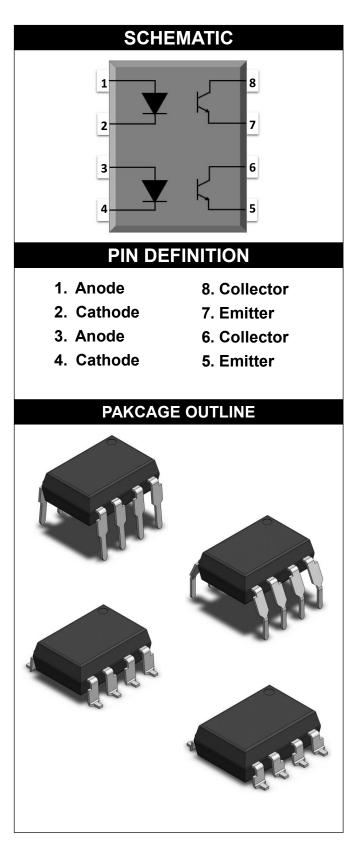
With the robust coplanar double mold structure, TD810 series provide the most stable isolation feature.

Features

- High isolation 5000 VRMS
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free (Optional)
- MSL class 1
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - cUL- CSA Component Acceptance
 Service Notice No. 5A

Applications

- Computer peripheral interface
- Microprocessor system interface



ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	VALUE	UNIT	NOTE			
INPUT							
Forward Current	IF	60	mA				
Peak Forward Current	I _{FP}	1	A 1				
Reverse Voltage	VR	6 V					
Input Power Dissipation	Pi	100	mW				
OUTPUT							
Collector - Emitter Voltage	V _{CEO}	80	V				
Emitter - Collector Voltage	V _{ECO}	6	V				
Collector Current	Ic	50	mA				
Output Power Dissipation	Po	150	mW				
COMMON							
Total Power Dissipation	Ptot	200	mW				
Isolation Voltage	Viso	5000	Vrms	2			
Operating Temperature	Topr	-55~110	°C				
Storage Temperature	Tstg	-55~125	°C				
Soldering Temperature	Tsol	260	°C				

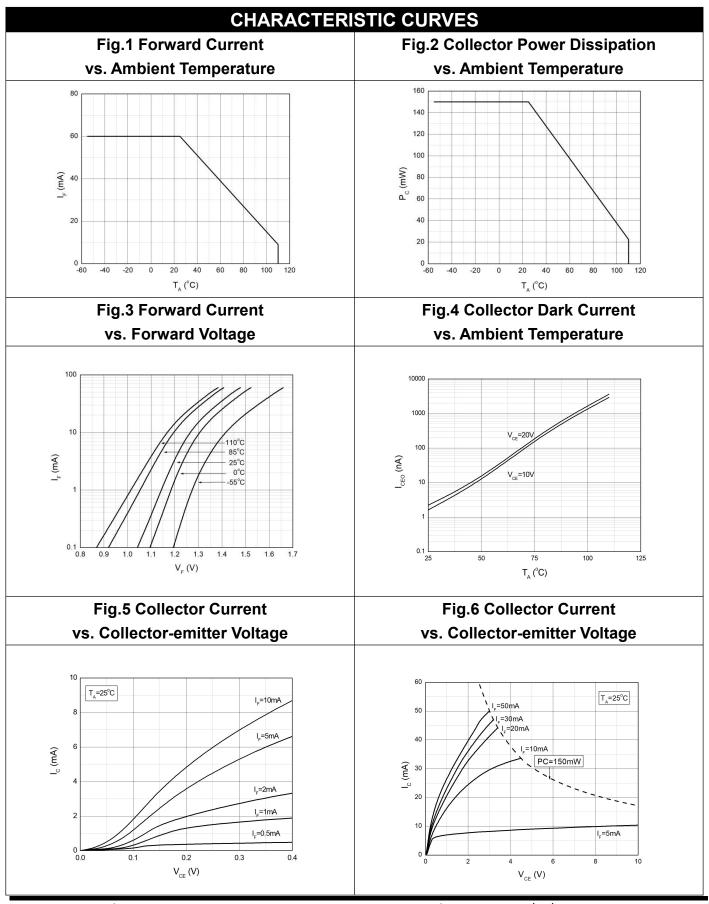
Note 1. 100µs pulse, 100Hz frequency Note 2. AC For 1 Minute, R.H. = 40 ~ 60%



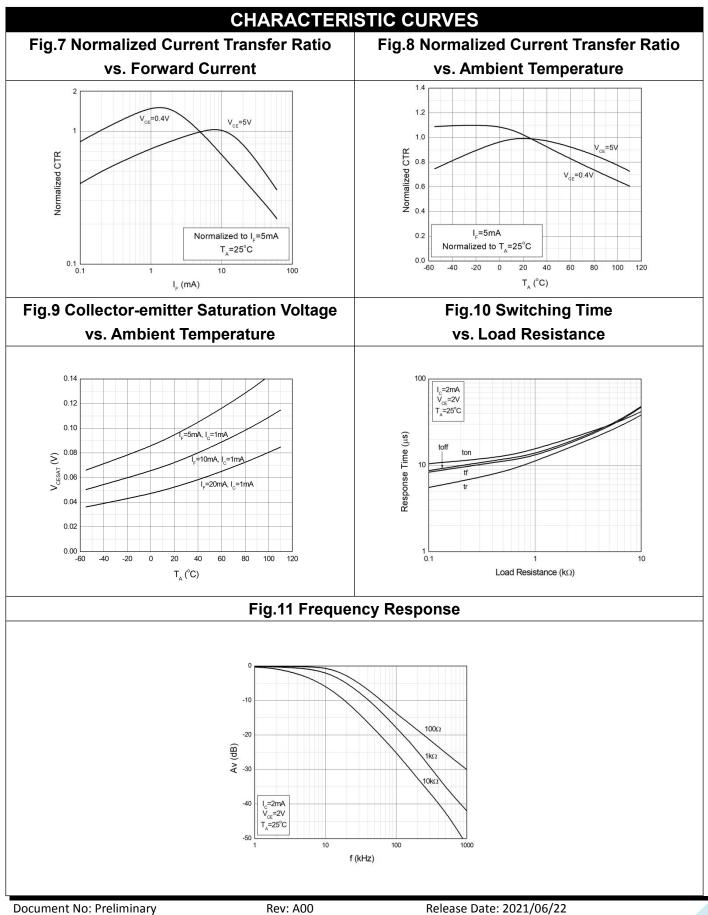
	ELECT		PTICA	L CHA	RAC	TER	ISTICS at Ta=25°C	
PARAME	ETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
	INPUT							
Forward V	Forward Voltage		-	1.24	1.4	V	IF=10mA	
Reverse C	Reverse Current		-	-	10	μA	VR=6V	
Input Capa	Input Capacitance		-	10	-	pF	V=0, f=1kHz	
				OUT	PUT			
Collector Dar	k Current	I _{CEO}	-	-	100	nA	VCE=20V, IF=0	
Collector-E	Emitter	D\/	80			V		
Breakdown	Voltage	BV _{CEO}	00	-	-	V	IC=0.1mA, IF=0	
Emitter-Co	Emitter-Collector Breakdown Voltage		6	-	-	V	IE=0.1mA, IF=0	
Breakdown								
	TRANSFER CHARACTERISTICS							
Current								
Transfer	TD827	CTR	130	-	400	%	IF=5mA, VCE=5V	
Ratio								
Collector-Emitter		V _{CE(sat)}		0.06	0.2	v	IF=20mA, IC=1mA	
Saturation '	Voltage	V CE(sat)	-	0.00	0.2	V	II -2011A, 10-111A	
Isolation Re	sistance	R _{ISO}	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Cap	acitance	CIO	-	0.4	1	pF	V=0, f=1MHz	
Response Time (Rise)		tr	-	6	18	μs	VCE=2V, IC=2mA	3
Response Ti	Response Time (Fall)		-	8	18	μs	RL=100Ω	3
Cut-off Fre	Cut-off Frequency		-	80	-	kHz	VCE=2V, IC=2mA RL=100Ω,-3dB	4

Note 3. Fig.14 Note 4. Fig.12&13



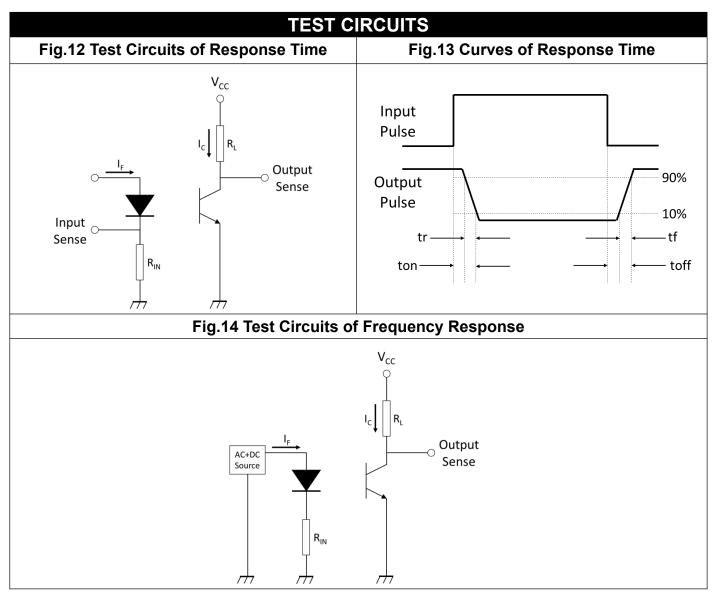




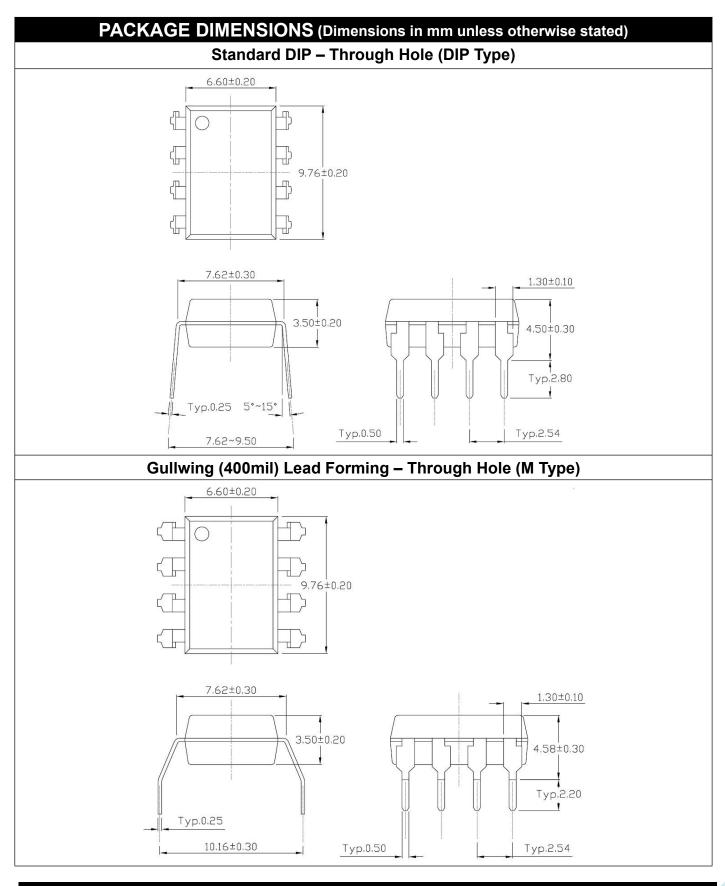




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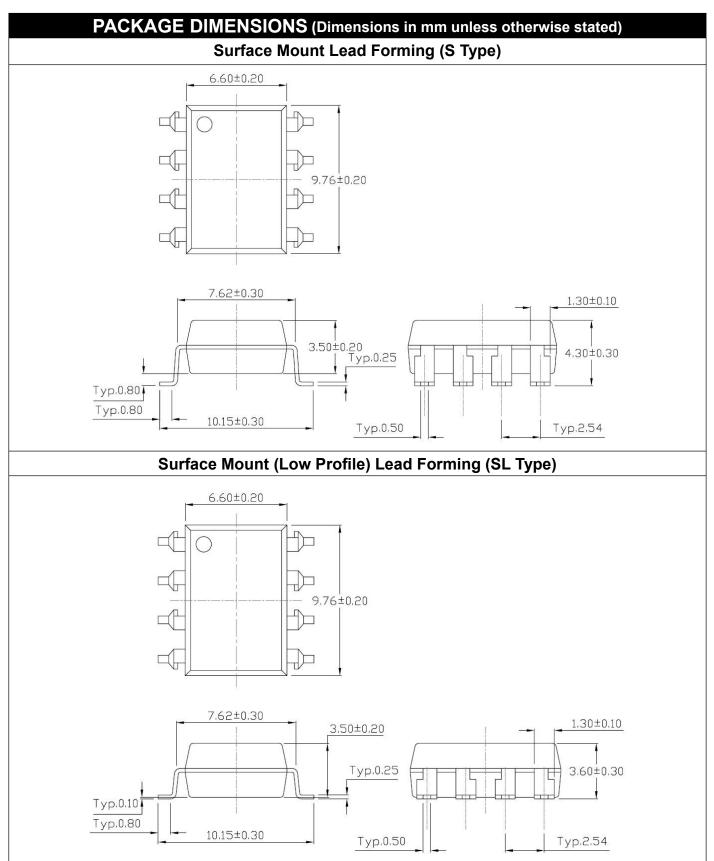




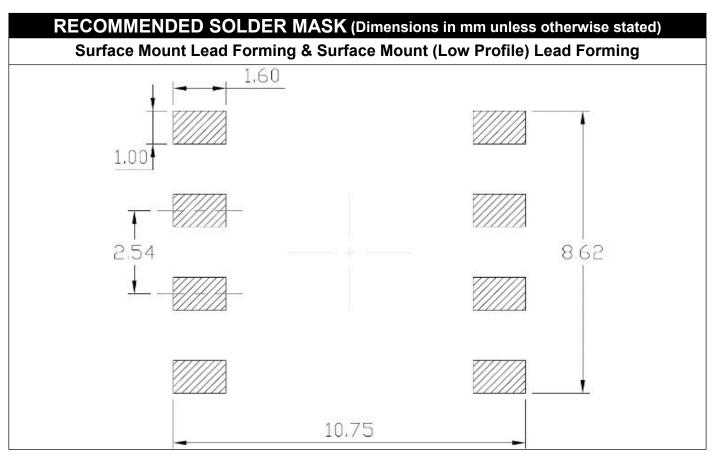


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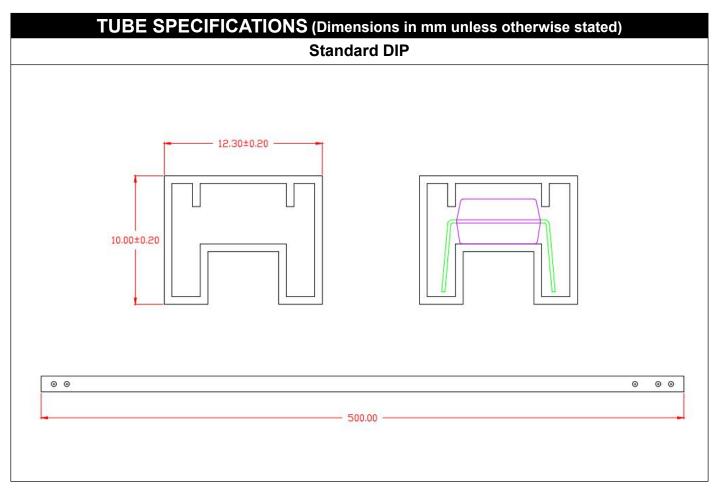




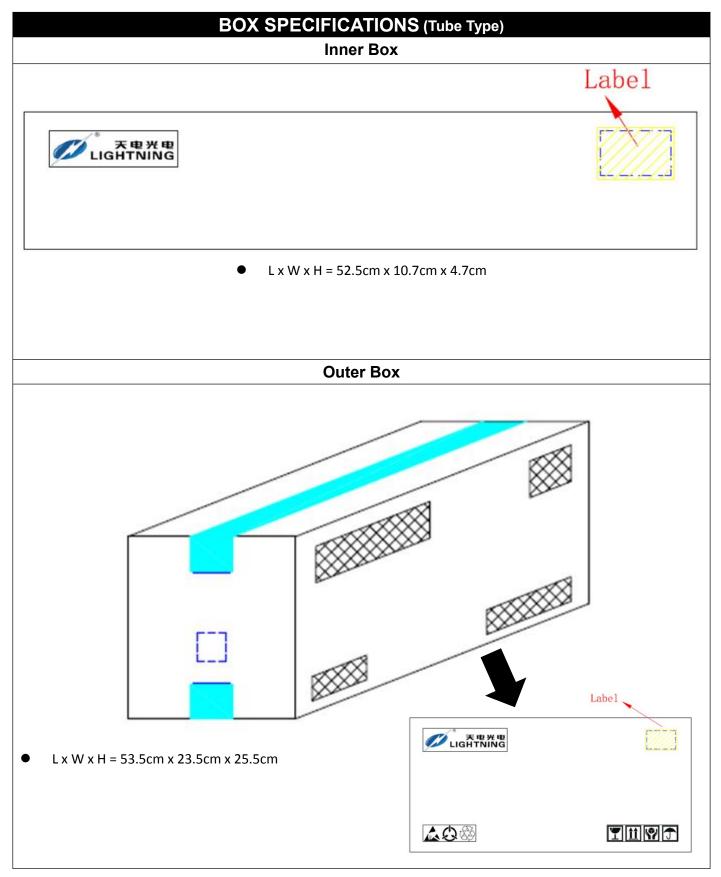




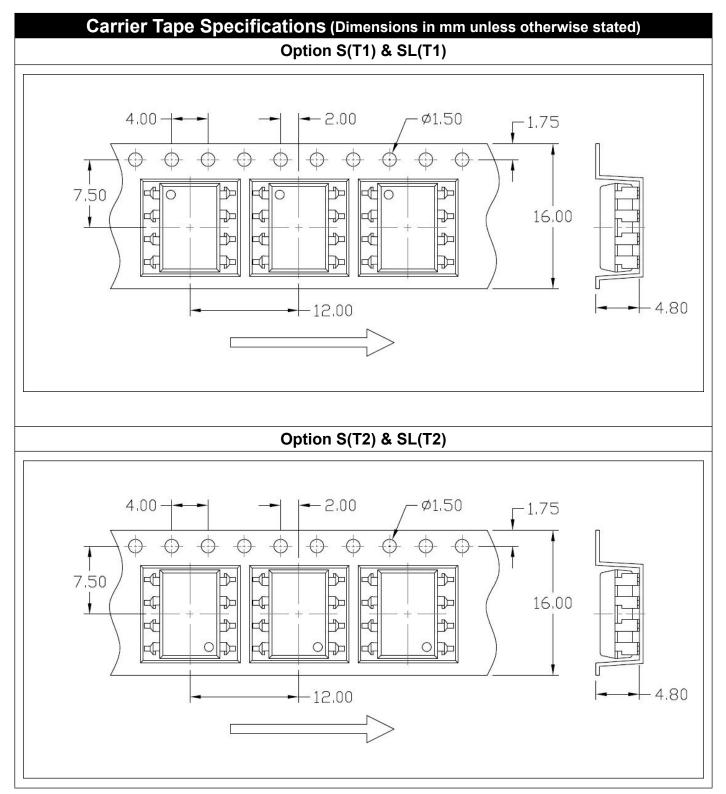




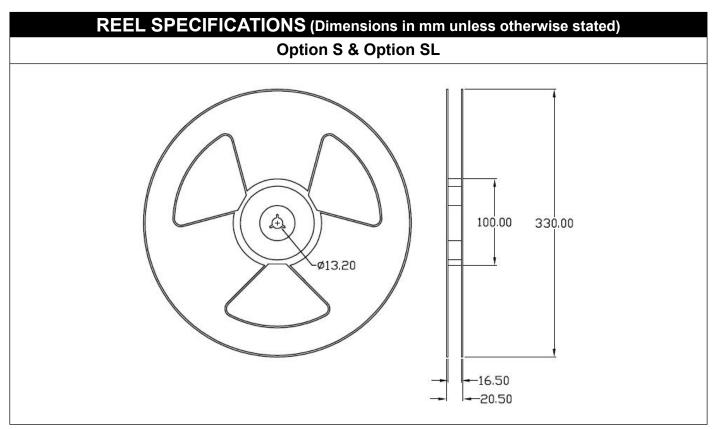


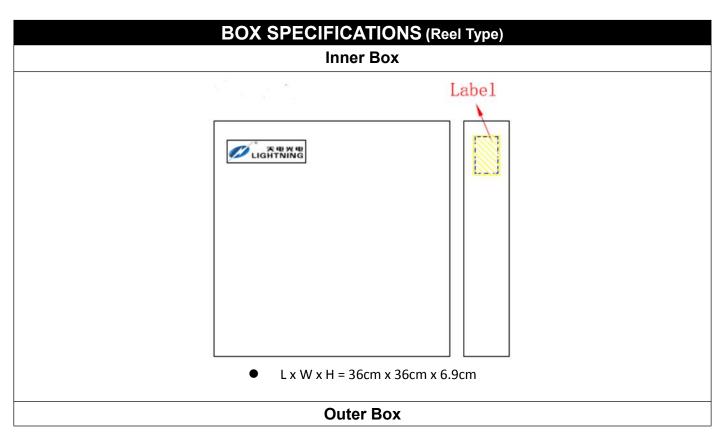




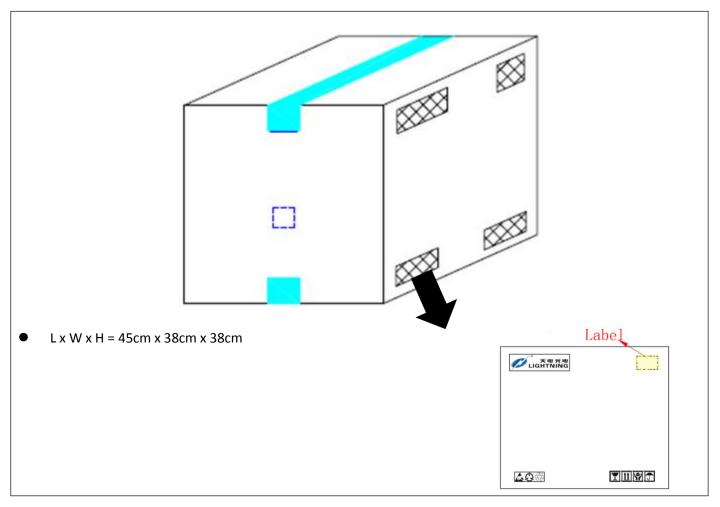














ORDERING AND MARKING INFORMATION					
MARKING INFORMATION					
TD 827 827 V Y X VYAWW M				: Company Abbr. : Part Number VDE Option : Fiscal Year : Manufacturing Code : Work Week	
ORDERING INFORMATION		LABEL INFORMATION			
TD827(Z)-GV(B)		A建天电光电有限公司 FUJIAN LIGHTNING OPTOELECTRONIC CO.,LTD Part No.:XXXXXXXXX Bin Code: X Lot No.: XXXXXXXXXX Date Code: XXXX QTY: XXX PCS			
TD – Company Abbr.					
827 – Part Number					
Y – Lead Form Option (M/S/SL/None)					
Z – Tape and Reel Option (T1/T2)					
G – Material Option					
(G: Green, None: Non-Green)		MSL:			
V – VDE Option (V or None)				Inchou Pulian	
B – Black(I	None:white)				
PACKING QUANTITY					
Option	Quantity	Quantity – Inner box		Quantity – Outer box	
None	40 Units/Tube	25 Tubes/Inner box		10 Inner box/Outer box = 10k Units	
М	40 Units/Tube	25 Tubes/Inner box		10 Inner box/Outer box = 10k Units	
S(T1)	1000 Units/Reel	3 Reels/Inner box		5 Inner box/Outer box = 15k Units	
S(T2)	1000 Units/Reel	3 Reels/Inner box		5 Inner box/Outer box = 15k Units	

1000 Units/Reel

1000 Units/Reel

SL(T1)

SL(T2)

3 Reels/Inner box

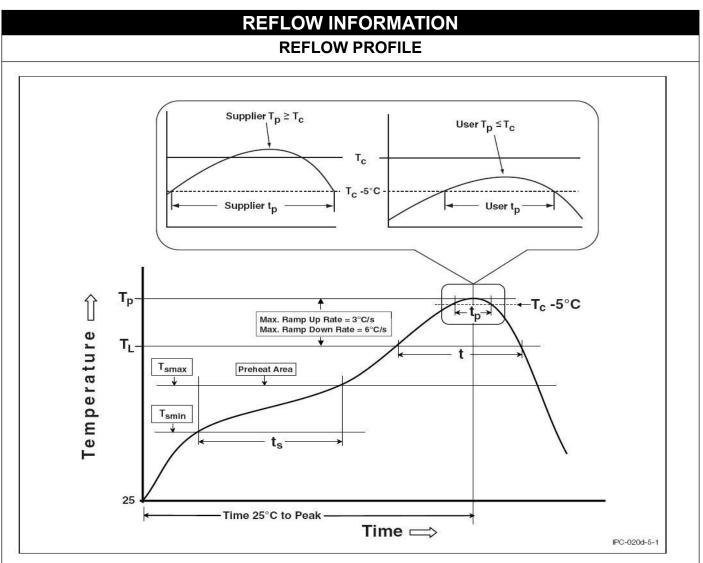
3 Reels/Inner box

5 Inner box/Outer box = 15k Units

5 Inner box/Outer box = 15k Units



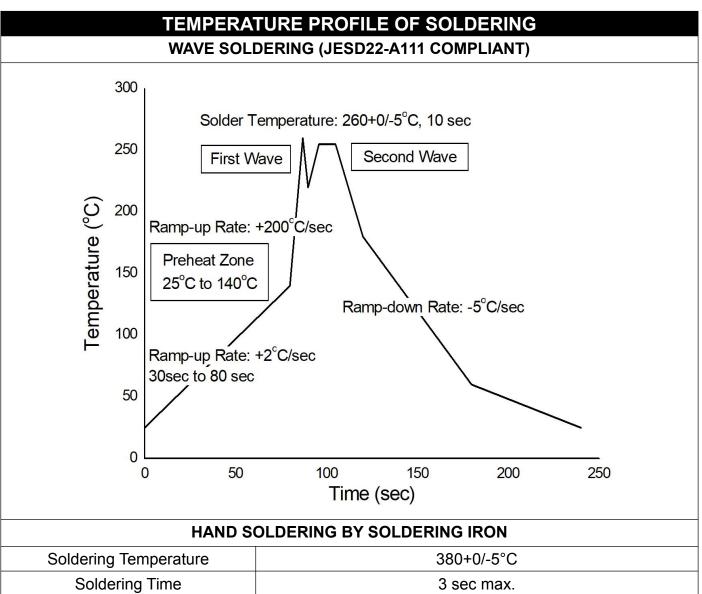




Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile	
Temperature Min. (Tsmin)	100	150°C	
Temperature Max. (Tsmax)	150	200°C	
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds	
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.	
Liquidous Temperature (TL)	183°C	217°C	
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds	
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C	
Time (tP) within 5°C of 260°C	20 seconds	30 seconds	
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max	
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.	

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- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



DISCLAIMER

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- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated in each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify LIGHTNING's terms and conditions of purchase, including but not limited to the warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.